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	LAYER 6	PWB 518391 REV B
	DATE : 7-21-17	

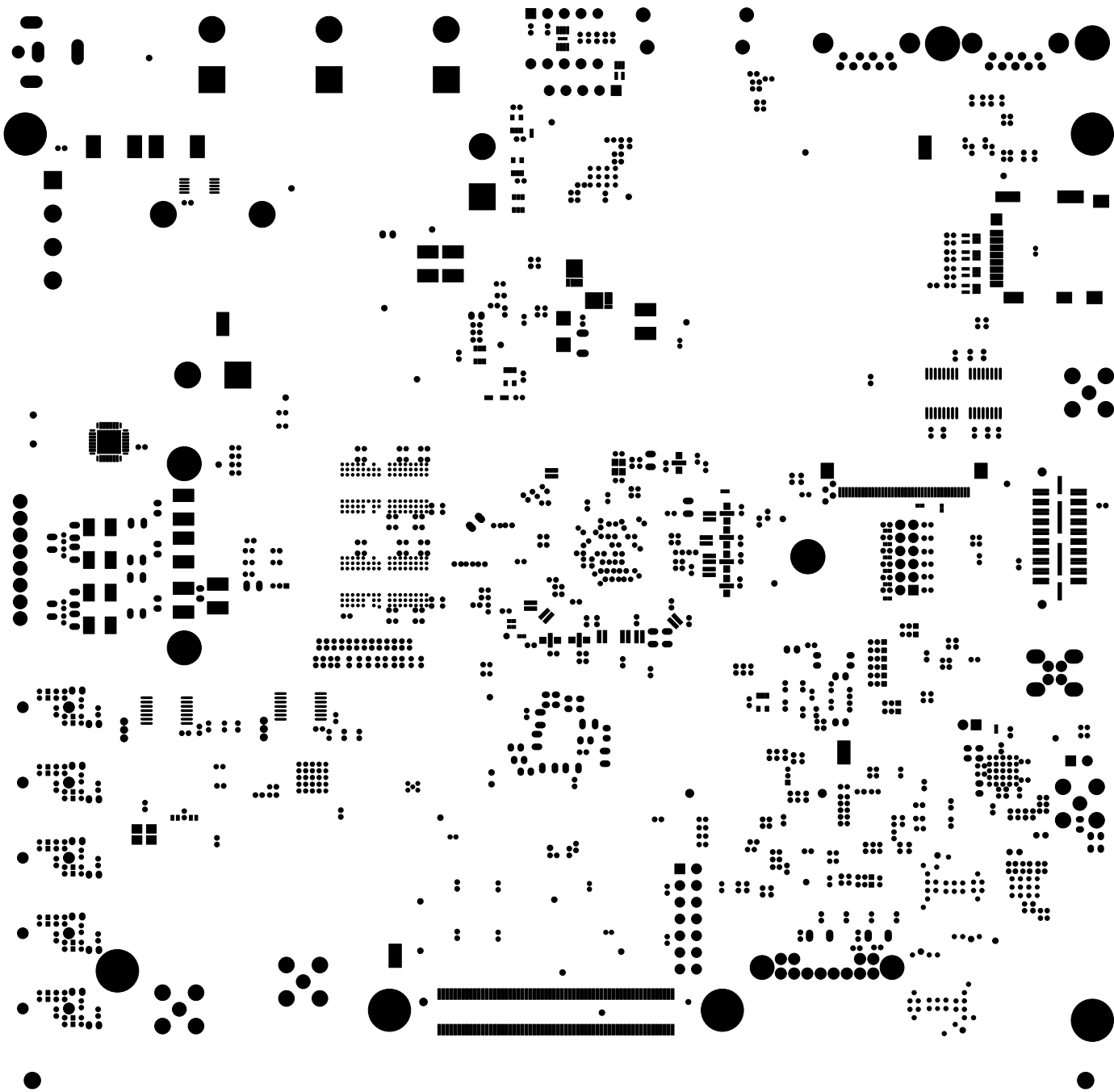


V22A 218930 REV A

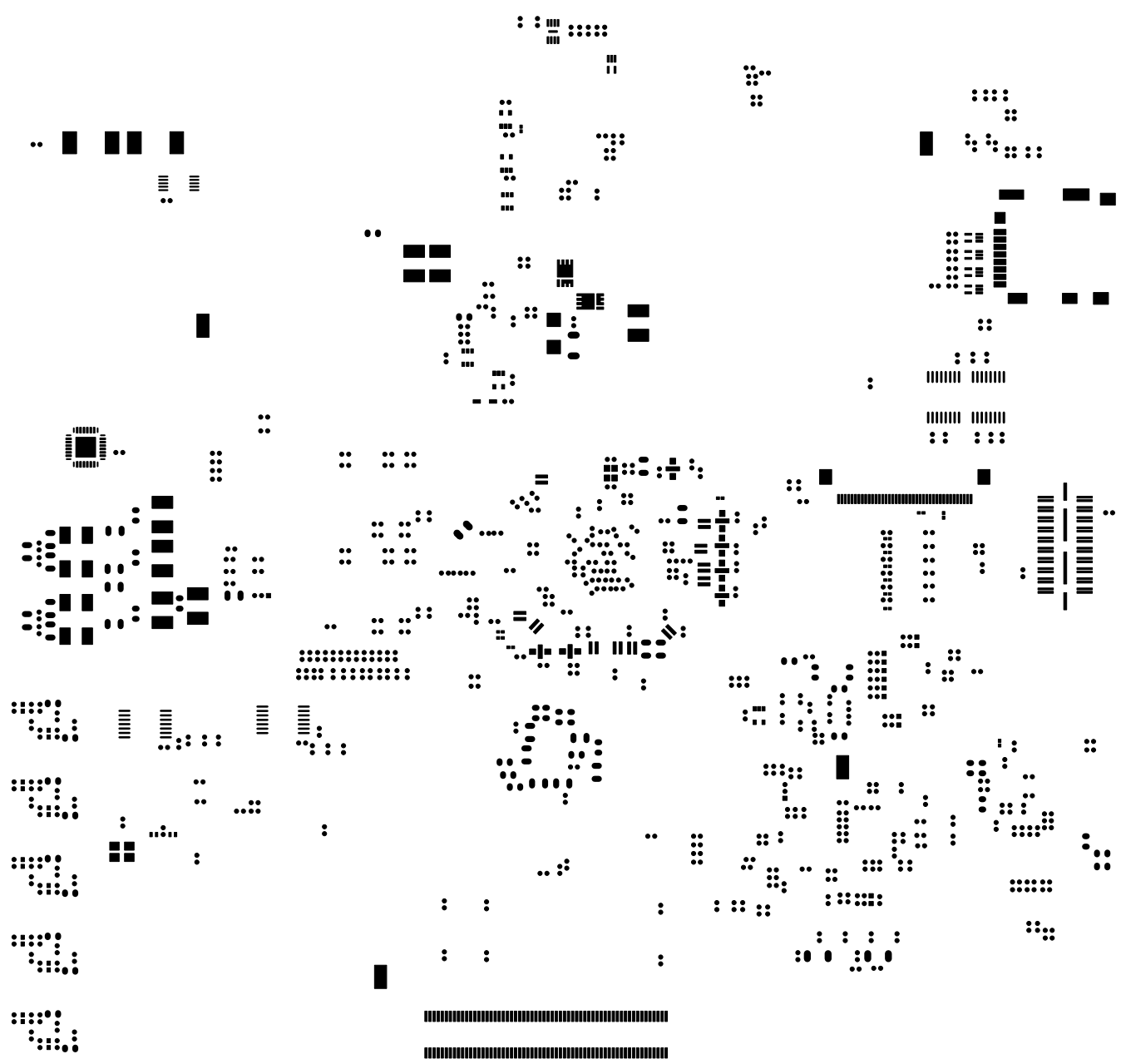
BSLK EXPANSION

NOT FCC APPROVED FOR RESALE

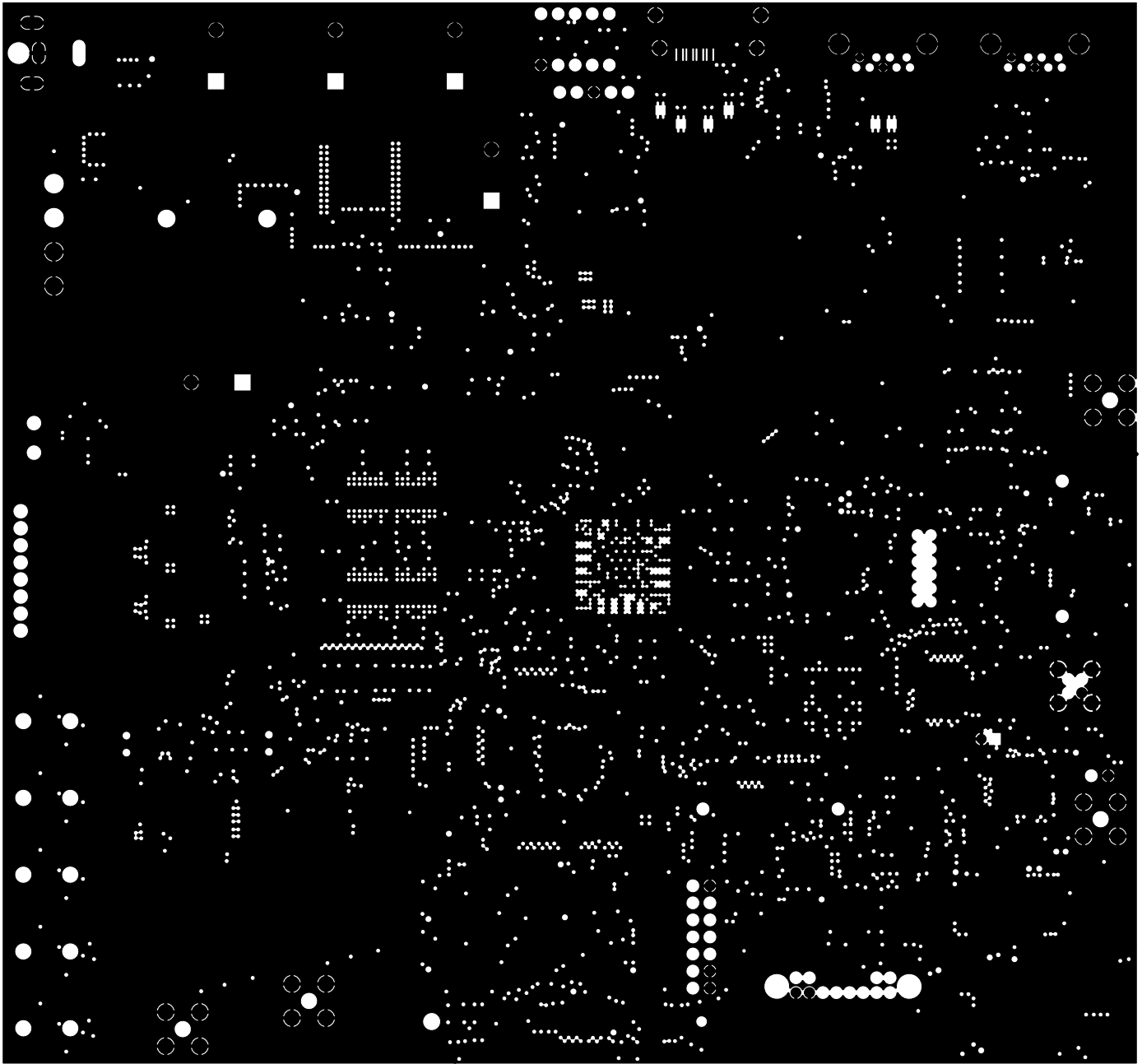
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BSLK	PWB 518391 REV B
DATE : 7-21-17	



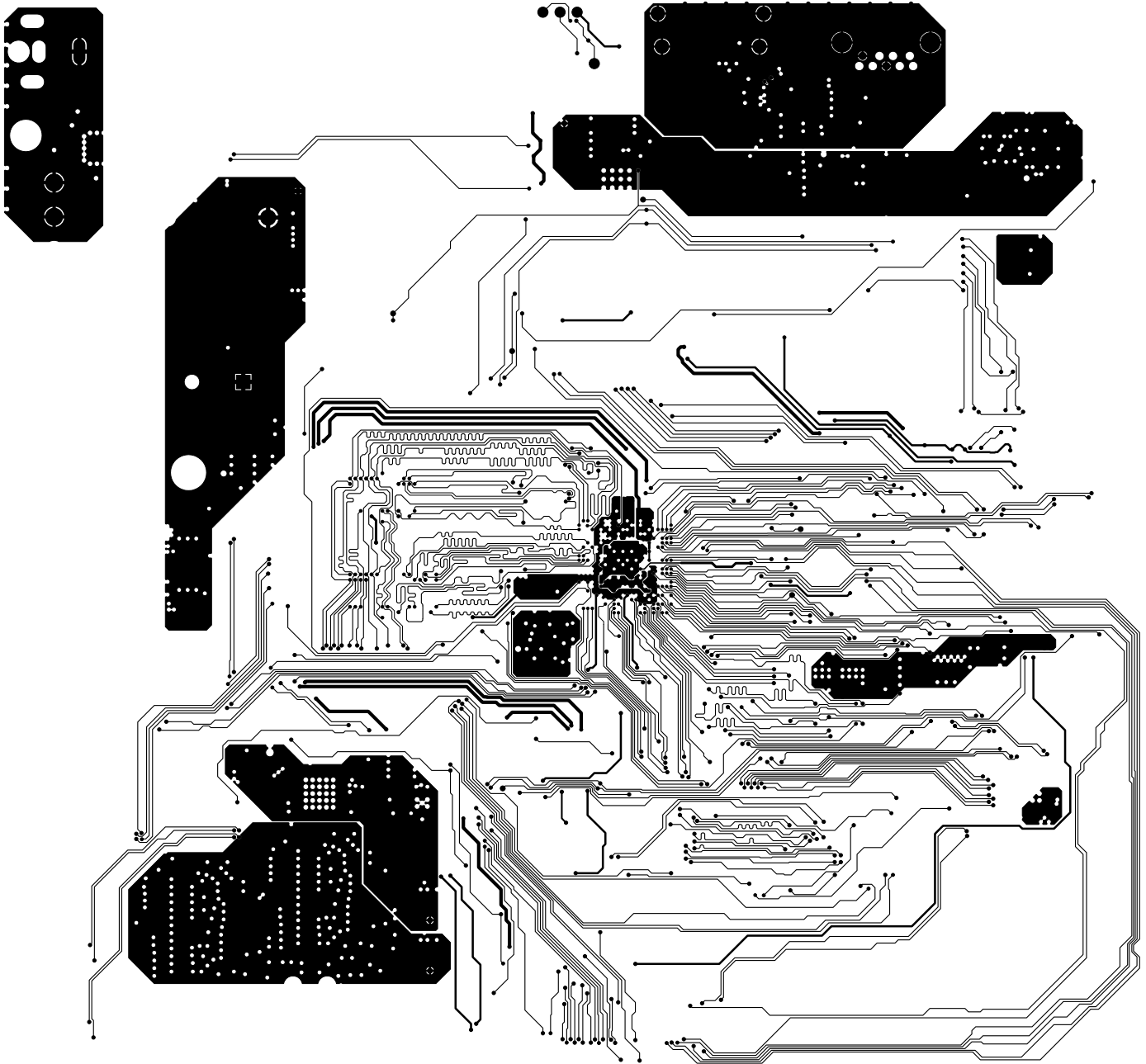
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	DATE : 7-21-17	



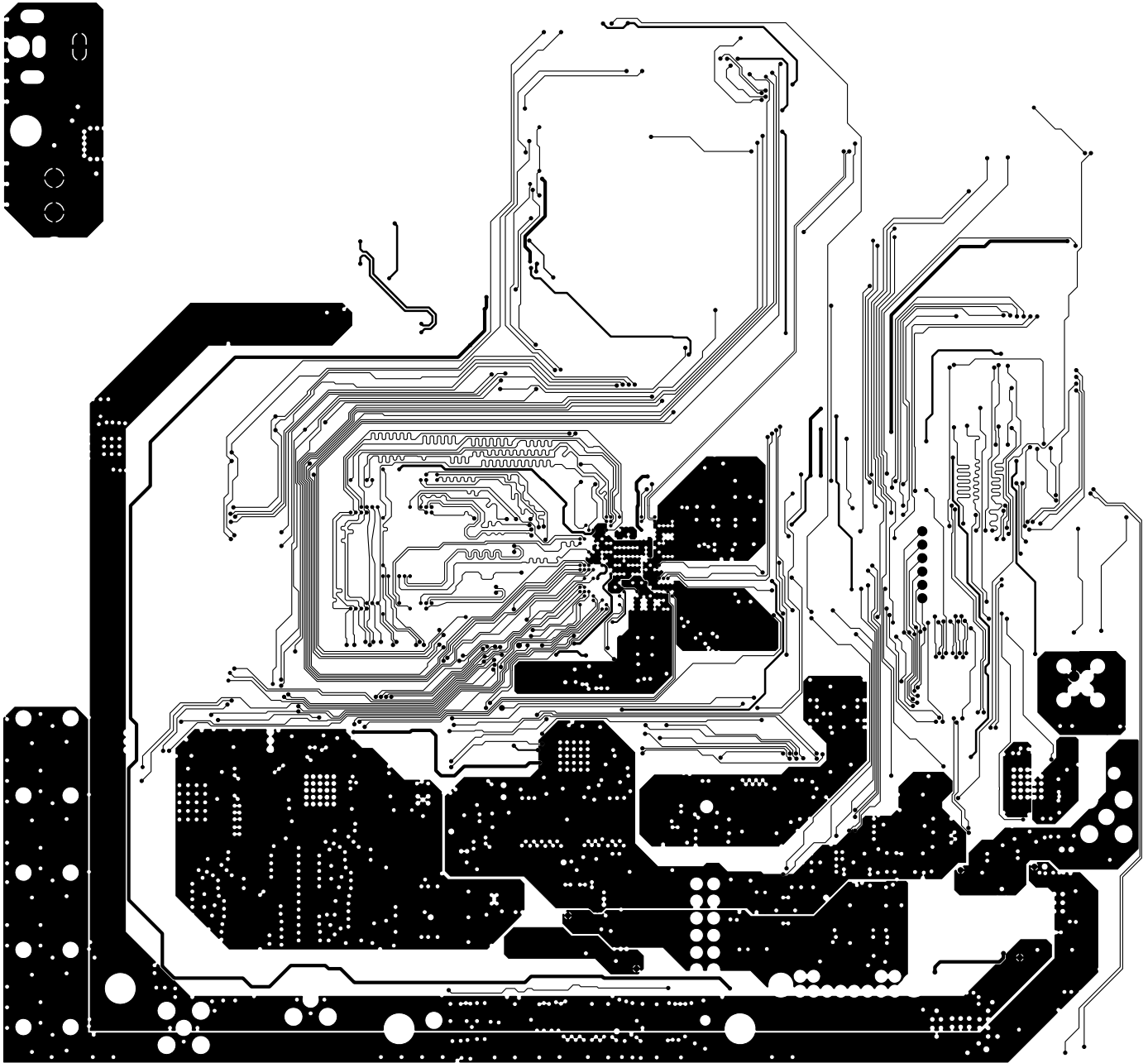
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		PWB 518391 REV B
	DATE : 7-21-17	



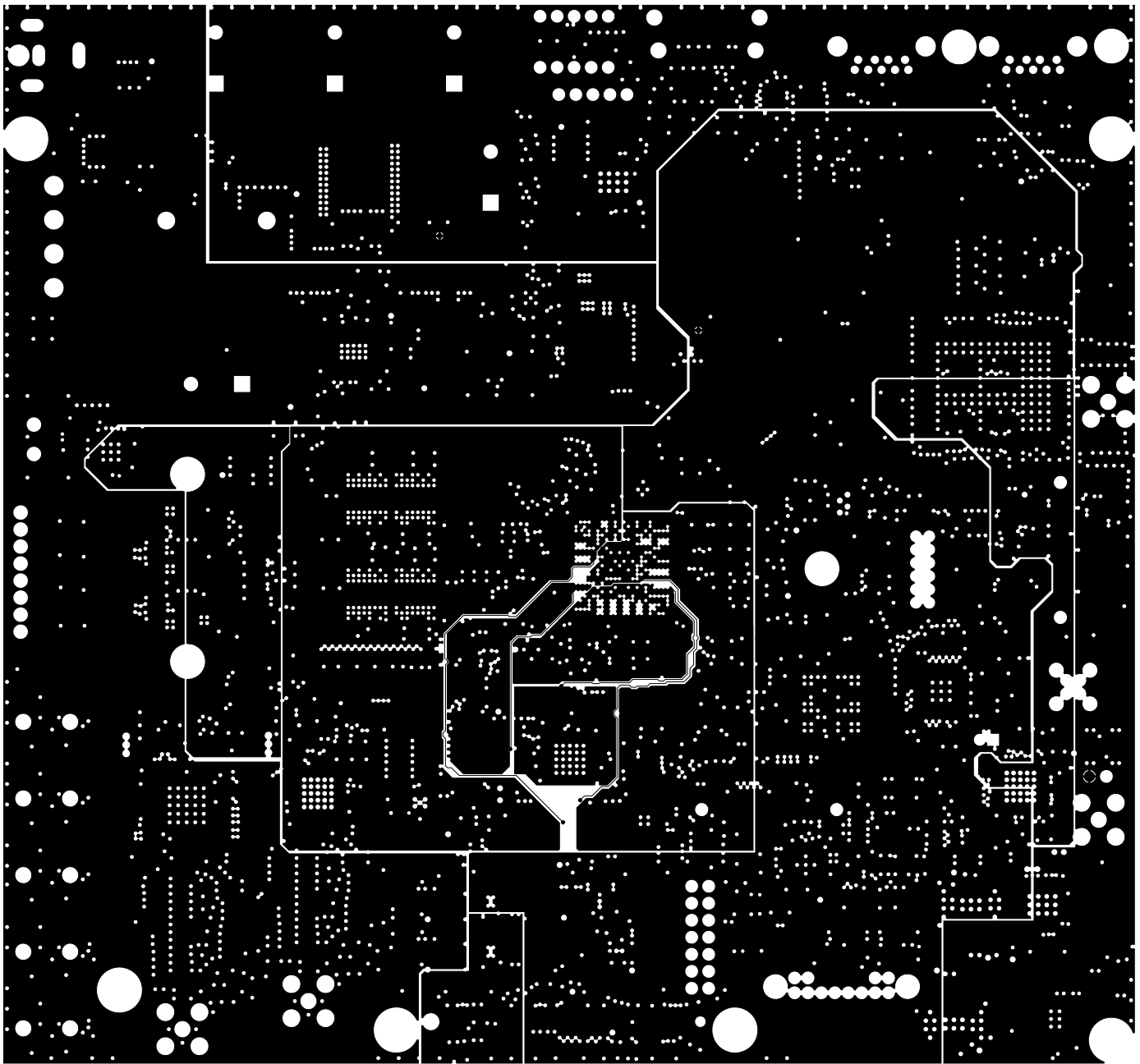
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	LAYER 2	PWB 518391 REV B
	DATE : 7-21-17	



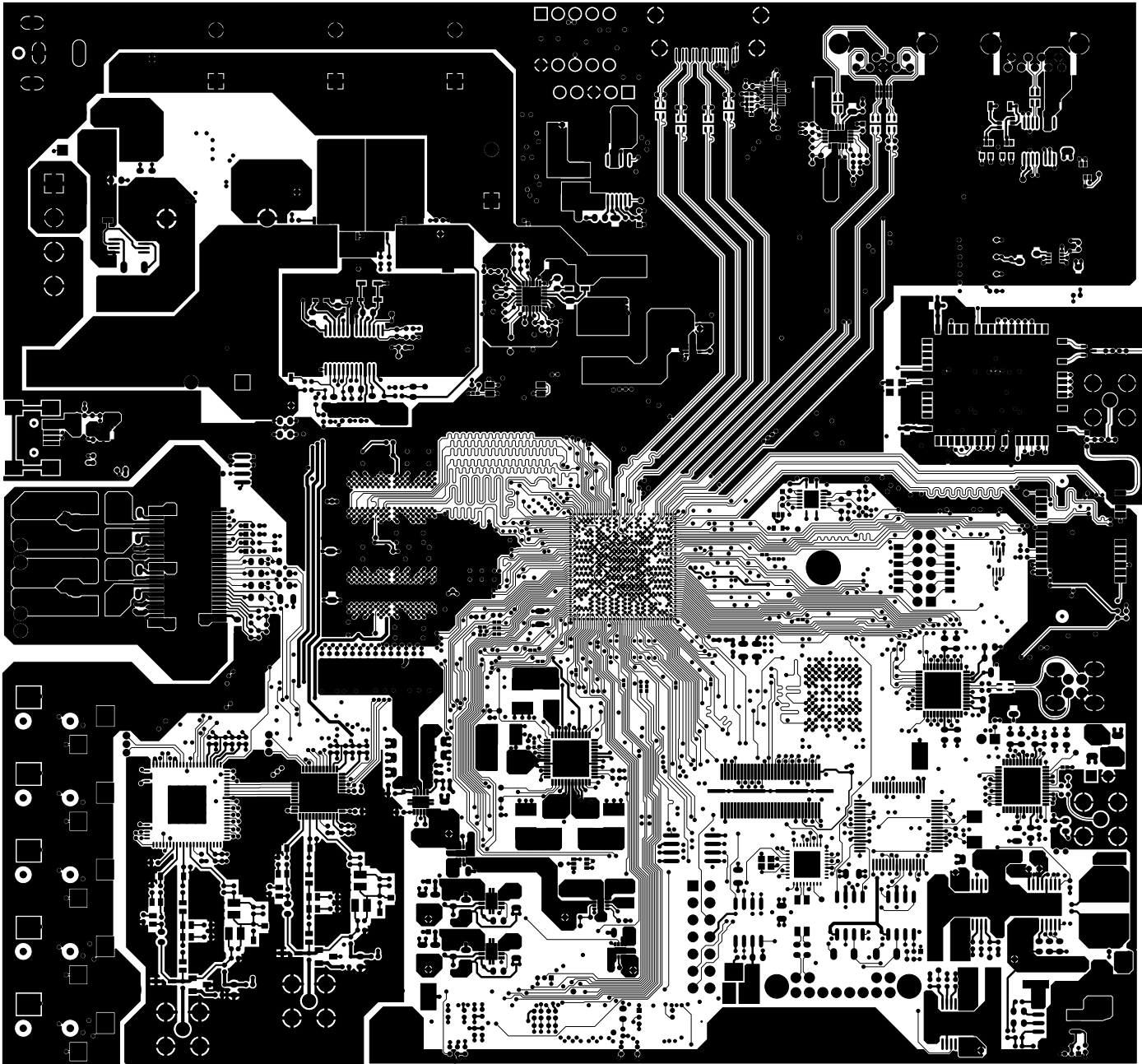
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	DATE : 7-21-17	



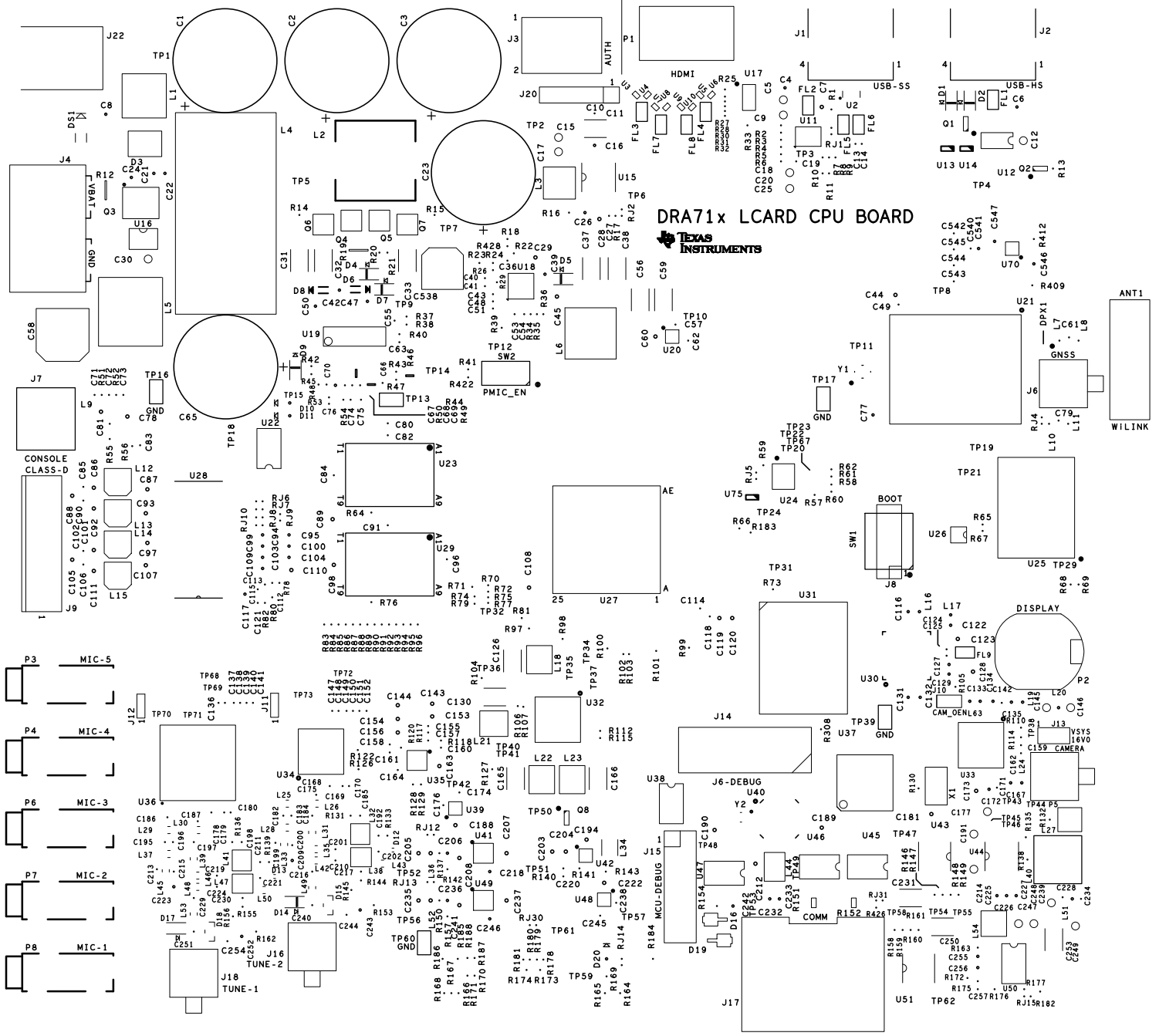
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	LAYER 4	PWB 518391 REV B
	DATE : 7-21-17	



	TEXAS INSTRUMENTS	
	LAYER 5	PWB 518391 REV B
	DATE : 7-21-17	



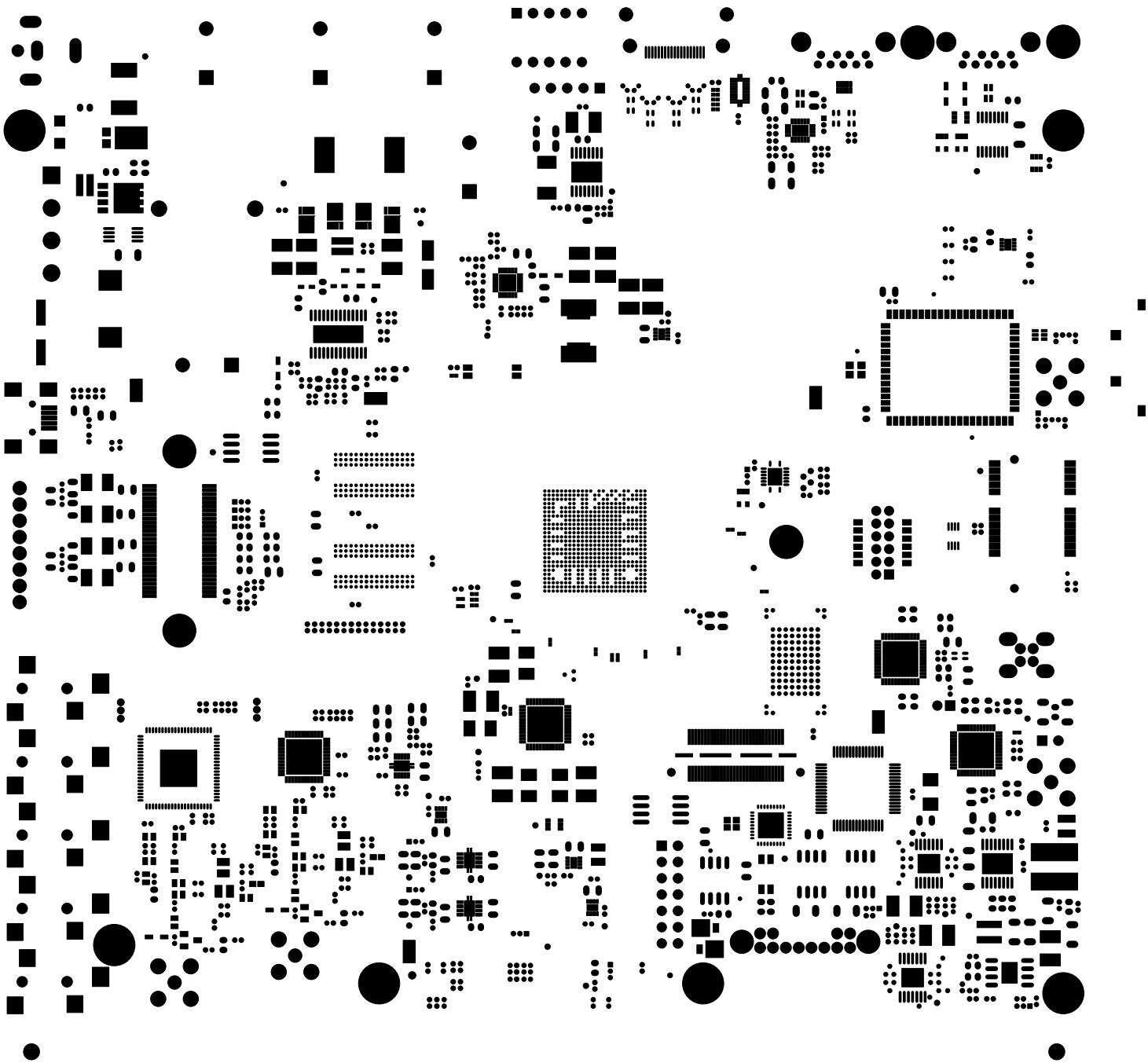
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	LAYER 1	PWB 518391 REV B
	DATE : 7-21-17	



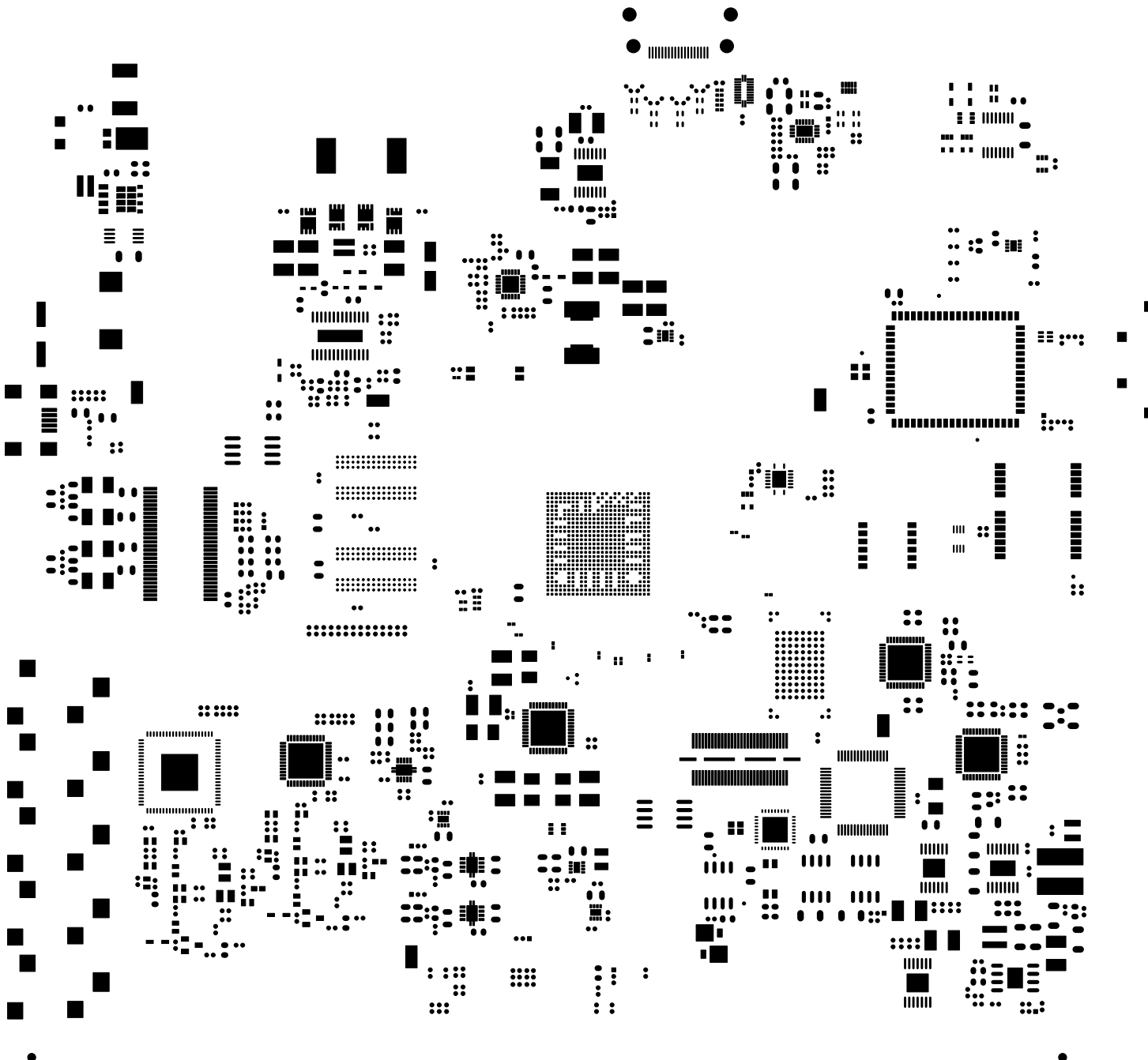
DRA71x LCARD CPU BOARD

TEXAS INSTRUMENTS

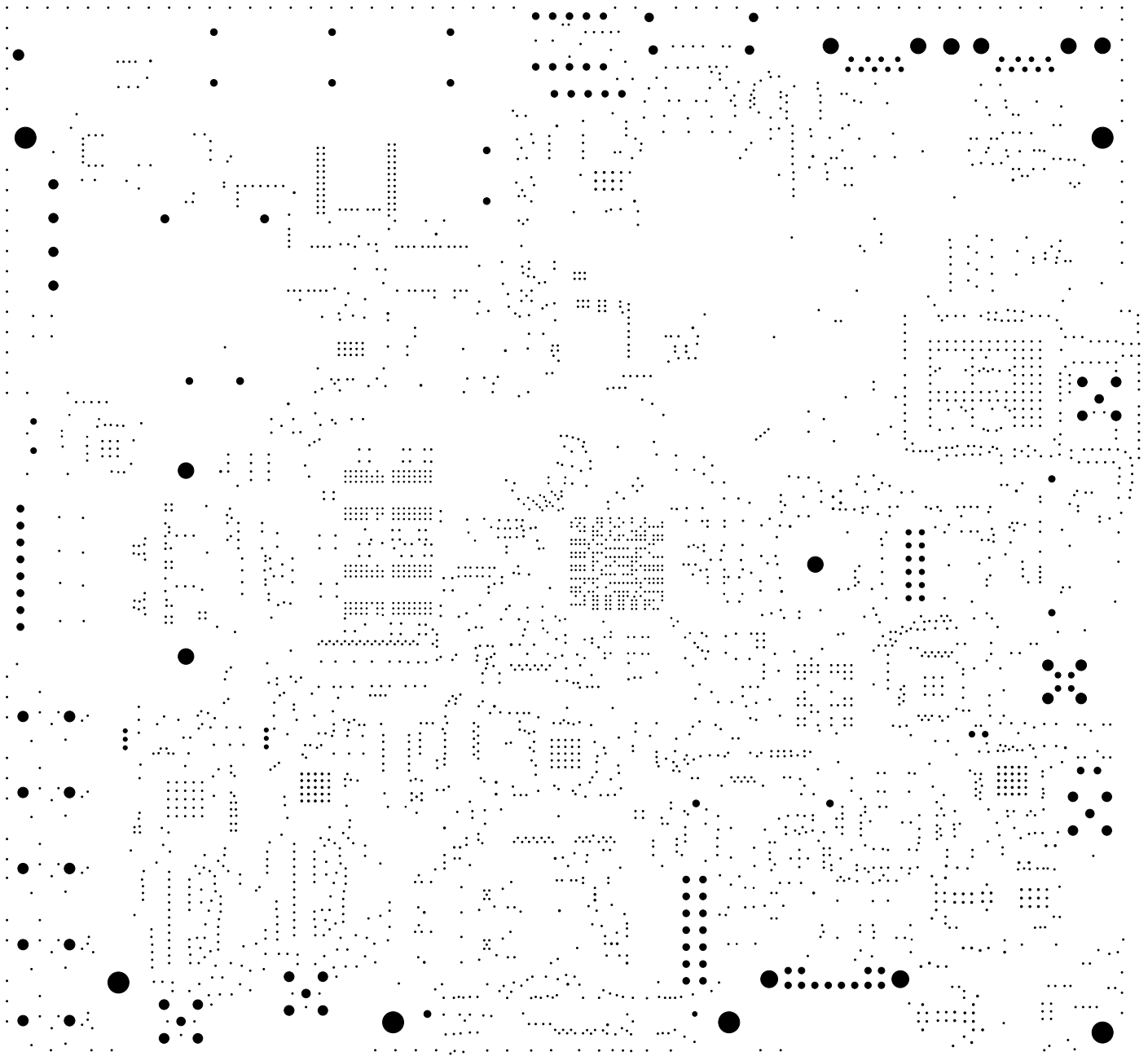
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TSLK	PWB 518391 REV B
DATE : 7-21-17	



	TEXAS INSTRUMENTS	
	SMC	PWB 518391 REV B
	DATE : 7-21-17	



	TEXAS INSTRUMENTS	
		PWB 518391 REV B
	DATE : 7-21-17	



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